



MAR 14 2002

PATENT & TRADEMARK OFFICE

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Classification::
Suggested Group Art Unit::
CD-ROM or CD_R?:: None
Number of CD disks::
Number of copies of CDs::
Sequence Submission:: No
Computer Readable Form (CRF)?:: No
Title:: SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE
Attorney Docket Number:: 10873.851US01
Request For Early Publication:: No
Request For Non-Publication:: No
Suggested Drawing Figure::
Total Drawing Sheets:: 15
Small Entity:: No
Latin Name::
Variety Denomination Name::
Petition Included:: No
Petition Type::
Licensed US Govt. Agency::
Contract or Grant Numbers::
Secrecy Order in Parent Appl.?:: No

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TC 2800 MAIL ROOM

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MAR 22 2002

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APR 29 2002

Technology Center 210

Initial 12/05/01

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Hiroaki
Middle Name::
Family Name:: Asada
Name Suffix::
City of Residence:: Takatsuki
State or Province of Residence:: Osaka
Country of Residence:: Japan
Street of mailing address:: 6-10-1-403, Makami-cho
City of mailing address:: Takatsuki
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 569-1121

Correspondence Information

Correspondence Customer Number:: 23552

Representative Information

Representative Customer Number::	23552
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Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2001-083422	03/22/01	Yes

Initial 12/05/01

Assignee Information

Assignee Name:: Matsushita Electric Industrial Co., Ltd.
Street of mailing address:: 1006-banchi, Oaza-Kadoma
City of mailing address:: Kadoma
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 571-8501

Initial 12/05/01